





ABSOLUTE MAXIMUM RATINGS (T <sub>amb</sub> = 25 °C, unless otherwise specified)				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
<b>OUTPUT</b>				
Supply voltage		V <sub>S</sub>	- 0.5 to 30	V
Output voltage		V <sub>O</sub>	- 0.5 to 25	V
Collector output current		I <sub>CO</sub>	8	mA
Derate linearly from 25 °C			1.33	mW/°C
Power dissipation	T <sub>amb</sub> ≤ 70 °C	P <sub>diss</sub>	50	mW
<b>COUPLER</b>				
Isolation test voltage	t = 1 s	V <sub>ISO</sub>	5300	V <sub>RMS</sub>
Pollution degree (DIN VDE0109)			2	
Creepage distance			≥ 7	mm
Clearance distance			≥ 7	mm
Derate linearly from 25 °C			1.93	mW/°C
Total package dissipation		P <sub>tot</sub>	145	mW
Comparative tracking index per DIN IEC112/VDE0303 part 1, group IIIa per DIN VDE6110			175	
Isolation resistance	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 25 °C	R <sub>IO</sub>	≥ 10 <sup>12</sup>	Ω
	V <sub>IO</sub> = 500 V, T <sub>amb</sub> = 100 °C	R <sub>IO</sub>	≥ 10 <sup>11</sup>	Ω
Storage temperature range		T <sub>stg</sub>	- 55 to + 125	°C
Ambient temperature range		T <sub>amb</sub>	- 55 to +100	°C
Soldering temperature (1)	max. 10 s, dip soldering distance to seating plane ≥ 1.5 mm	T <sub>slid</sub>	260	°C

**Notes**

- Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.

(1) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).

ELECTRICAL CHARACTERISTICS (T <sub>amb</sub> = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
<b>INPUT (1)</b>							
Forward voltage	I <sub>F</sub> = 16 mA		V <sub>F</sub>		1.33	1.9	V
Breakdown voltage	I <sub>R</sub> = 10 μA		V <sub>BR</sub>	4.5			V
Reverse current	V <sub>R</sub> = 4.5 V		I <sub>R</sub>		0.5	10	μA
Capacitance	V <sub>R</sub> = 0 V, f = 1 MHz		C <sub>O</sub>		30		pF
Temperature coefficient of forward voltage	I <sub>F</sub> = 16 mA		ΔV <sub>F</sub> /ΔT <sub>amb</sub>		- 1.7		mV/°C
<b>OUTPUT</b>							
Logic low supply current	I <sub>F</sub> = 16 mA, V <sub>O</sub> = open, V <sub>CC</sub> = 4.5 V		I <sub>CCL</sub>		100	200	μA
Supply current, logic high	I <sub>F</sub> = 0 mA, V <sub>O</sub> = open, V <sub>CC</sub> = 15 V		I <sub>CCH</sub>		0.01	4	μA
Logic low output voltage	I <sub>F</sub> = 16 mA, V <sub>CC</sub> = 4.5 V, I <sub>O</sub> = 1.1 mA	SFH6325	V <sub>OL</sub>		0.1	0.5	V
	I <sub>F</sub> = 16 mA, V <sub>CC</sub> = 4.5 V, I <sub>O</sub> = 3 mA	SFH6326	V <sub>OL</sub>		0.1	0.5	V
Logic high output current	I <sub>F</sub> = 0 mA, V <sub>O</sub> = V <sub>CC</sub> = 5.5 V		I <sub>OH</sub>		3	500	nA
	I <sub>F</sub> = 0 mA, V <sub>O</sub> = V <sub>CC</sub> = 15 V		I <sub>OH</sub>			50	μA
Channel to channel (2) crosstalk	I <sub>F</sub> = 16 mA, V <sub>O</sub> = V <sub>CC</sub> = 5.5 V		I <sub>OH-XT</sub>			500	nA
<b>COUPLER</b>							
Capacitance (input to output)	f = 1 MHz		C <sub>IO</sub>		0.6		pF

**Notes**

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

(1) T<sub>amb</sub> = 0 °C to 70 °C, unless otherwise specified.

(2) To measure crosstalk, turn on the LED for channel 1 and the output current for channel 2 in logic high. Repeat for channel 2.

<b>CURRENT TRANSFER RATIO</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
Current transfer ratio	$I_F = 16\text{ mA}$ , $V_{CC} = 4.5\text{ V}$ , $V_O = 0.4\text{ V}$ , $T_{amb} = 25\text{ }^{\circ}\text{C}$	SFH6325	CTR	7	16		%
		SFH6326	CTR	19	35		%
	$I_F = 16\text{ mA}$ , $V_{CC} = 4.5\text{ V}$ , $V_O = 0.5\text{ V}$ , $T_{amb} = 0\text{ }^{\circ}\text{C}$ to $70\text{ }^{\circ}\text{C}$	SFH6325	CTR	5			%
		SFH6326	CTR	15			%

<b>SWITCHING CHARACTERISTICS</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
High to low	$I_F = 16\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 4.1\text{ k}\Omega$	SFH6325	$t_{PHL}$		0.3	1.5	$\mu\text{s}$
	$I_F = 16\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1.9\text{ k}\Omega$	SFH6326	$t_{PHL}$		0.2	0.8	$\mu\text{s}$
Low to high	$I_F = 16\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 4.1\text{ k}\Omega$	SFH6325	$t_{PLH}$		0.6	1.5	$\mu\text{s}$
	$I_F = 16\text{ mA}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1.9\text{ k}\Omega$	SFH6326	$t_{PLH}$		0.5	0.8	$\mu\text{s}$

<b>COMMON MODE TRANSIENT IMMUNITY</b> ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
CMTI at logic high level output	$I_F = 0\text{ mA}$ , $C_{CM} = 10\text{ V}_{P-P}$ , $V_{CC} = 5\text{ V}$ , $R_L = 4.1\text{ k}\Omega$	SFH6325	$CM_H$		1000		$\text{V}/\mu\text{s}$
	$I_F = 0\text{ mA}$ , $C_{CM} = 10\text{ V}_{P-P}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1.9\text{ k}\Omega$	SFH6326	$CM_H$		1000		$\text{V}/\mu\text{s}$
CMTI at logic low level output	$I_F = 16\text{ mA}$ , $C_{CM} = 10\text{ V}_{P-P}$ , $V_{CC} = 5\text{ V}$ , $R_L = 4.1\text{ k}\Omega$	SFH6325	$CM_L$		1000		$\text{V}/\mu\text{s}$
	$I_F = 16\text{ mA}$ , $C_{CM} = 10\text{ V}_{P-P}$ , $V_{CC} = 5\text{ V}$ , $R_L = 1.9\text{ k}\Omega$	SFH6326	$CM_L$		1000		$\text{V}/\mu\text{s}$

**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified)


Fig. 1 - LED Forward Current vs. Forward Voltage

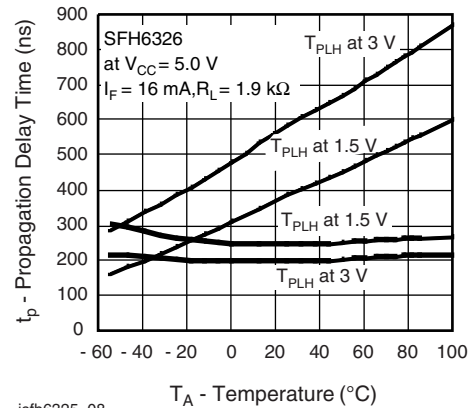


Fig. 2 - Permissible Forward LED Current vs. Temperature



isfh6325\_05

Fig. 3 - Permissible Power Dissipation vs. Temperature



isfh6325\_08

Fig. 6 - Propagation Delay vs. Ambient Temperature



isfh6325\_06

Fig. 4 - Output Current vs. Output Voltage



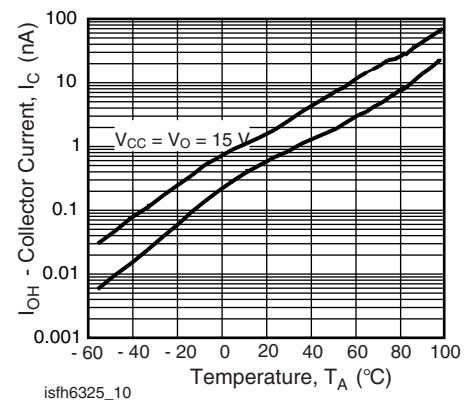
isfh6325\_09

Fig. 7 - Propagation Delay vs. Ambient Temperature



isfh6325\_07

Fig. 5 - Output Current vs. Temperature



isfh6325\_10

Fig. 8 - Logic High Output Current vs. Temperature



Fig. 9 - Small Signal Current Transfer Ratio vs. Input Current

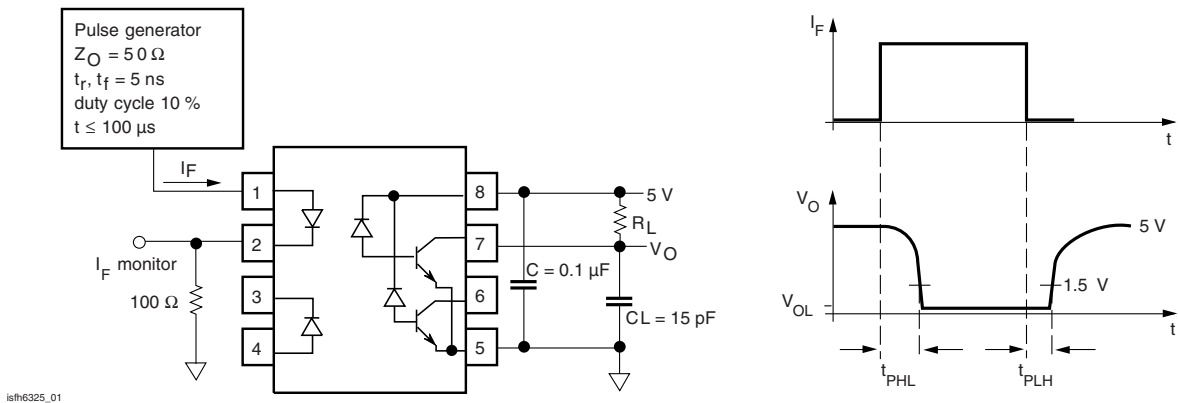


Fig. 10 - Switching Time and Test Circuit

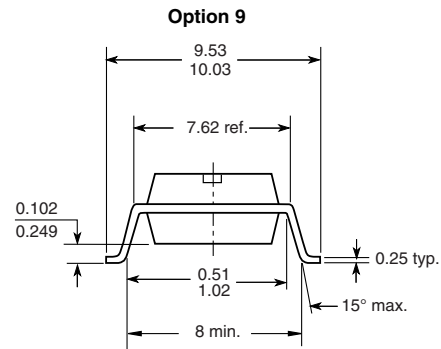


Fig. 11 - Waveform and Test Circuit for Common Mode Transient Immunity

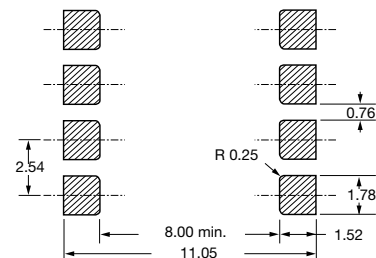
## PACKAGE DIMENSIONS in millimeters



i178006



18450



## PACKAGE MARKING



21764-69

### Notes

- Only options 1 and 7 are reflected in the package marking.
- The VDE Logo is only marked on option1 parts.
- Tape and reel suffix (T) is not part of the package marking.



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